Multilayer Ceramic Chip Capacitors

1 of 3 Creation Date : April 17, 2017 (GMT)

C1005X7R1C104K050BC



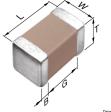






TDK item description C1005X7R1C104KT****

Applications	Commercial Grade Please refer to Part No. CGA2B1X7R1C104K050BC for Automotive use.	
Feature	General (Up to 50V)	
Series	C1005 [EIA 0402]	
Status	Production (Not Recommended for New Design)	



	Size	
Length(L)	1.00mm ±0.05mm	
Width(W)	0.50mm ±0.05mm	
Thickness(T)	0.50mm ±0.05mm	
Terminal Width(B)	0.10mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.30mm to 0.50mm	
Recommended Land Pattern (PB)	0.35mm to 0.45mm	
Recommended Land Pattern (PC)	0.40mm to 0.60mm	

	Electrical Characteristics	
Capacitance	100nF ±10%	
Rated Voltage	16VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	1000ΜΩ	

Other		
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	10000pcs	

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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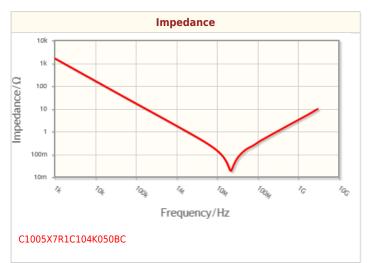


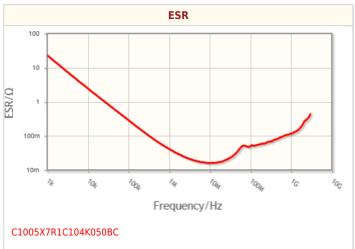


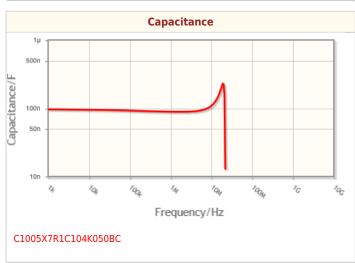


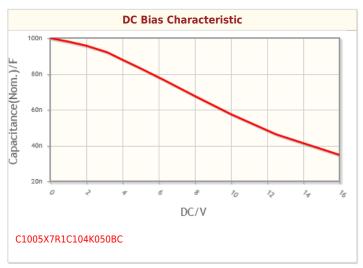


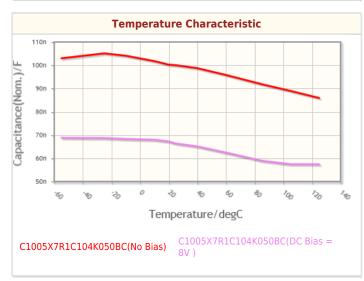
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

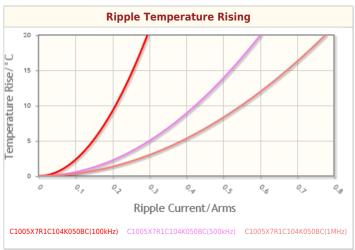












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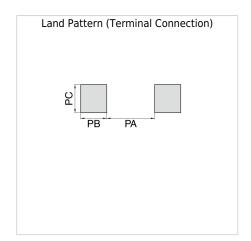






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Associated Images



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